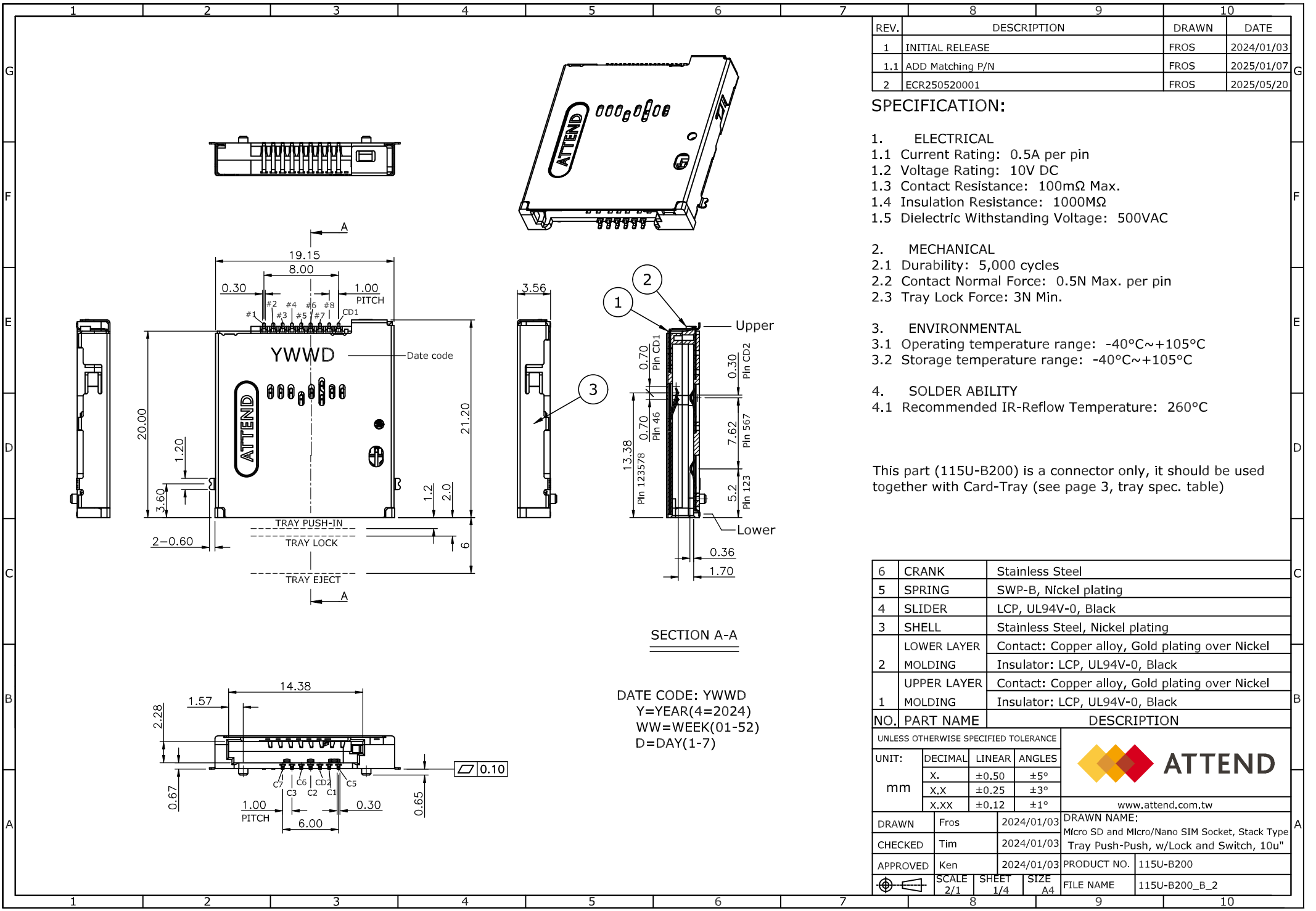




REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2024/01/03
1.1	ADD Matching P/N	FROS	2025/01/07
2	ECR250520001	FROS	2025/05/20

SPECIFICATION:

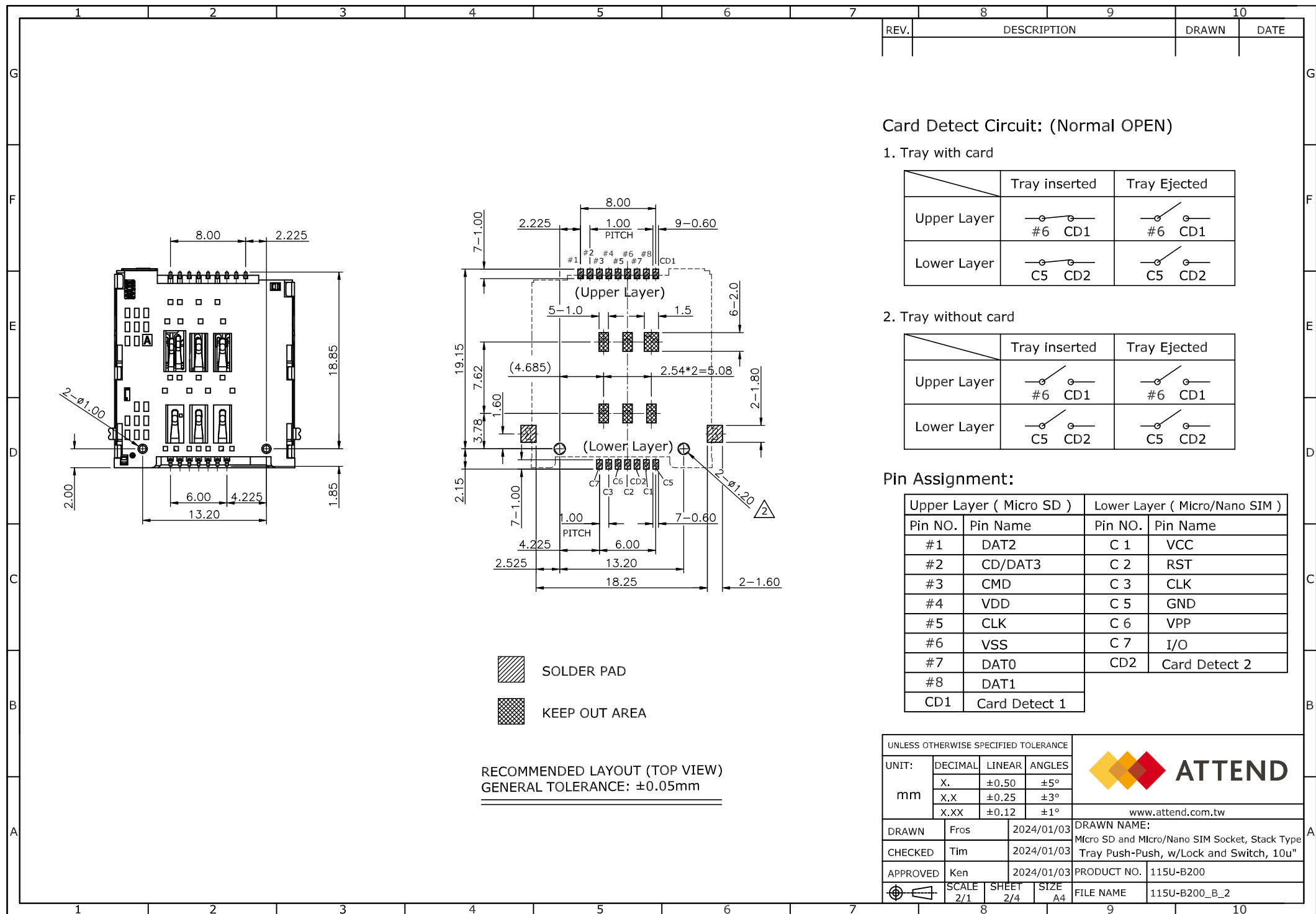
- ELECTRICAL
 - Current Rating: 0.5A per pin
 - Voltage Rating: 10V DC
 - Contact Resistance: 100mΩ Max.
 - Insulation Resistance: 1000MΩ
 - Dielectric Withstanding Voltage: 500VAC
- MECHANICAL
 - Durability: 5,000 cycles
 - Contact Normal Force: 0.5N Max. per pin
 - Tray Lock Force: 3N Min.
- ENVIRONMENTAL
 - Operating temperature range: -40°C~+105°C
 - Storage temperature range: -40°C~+105°C
- SOLDER ABILITY
 - Recommended IR-Reflow Temperature: 260°C

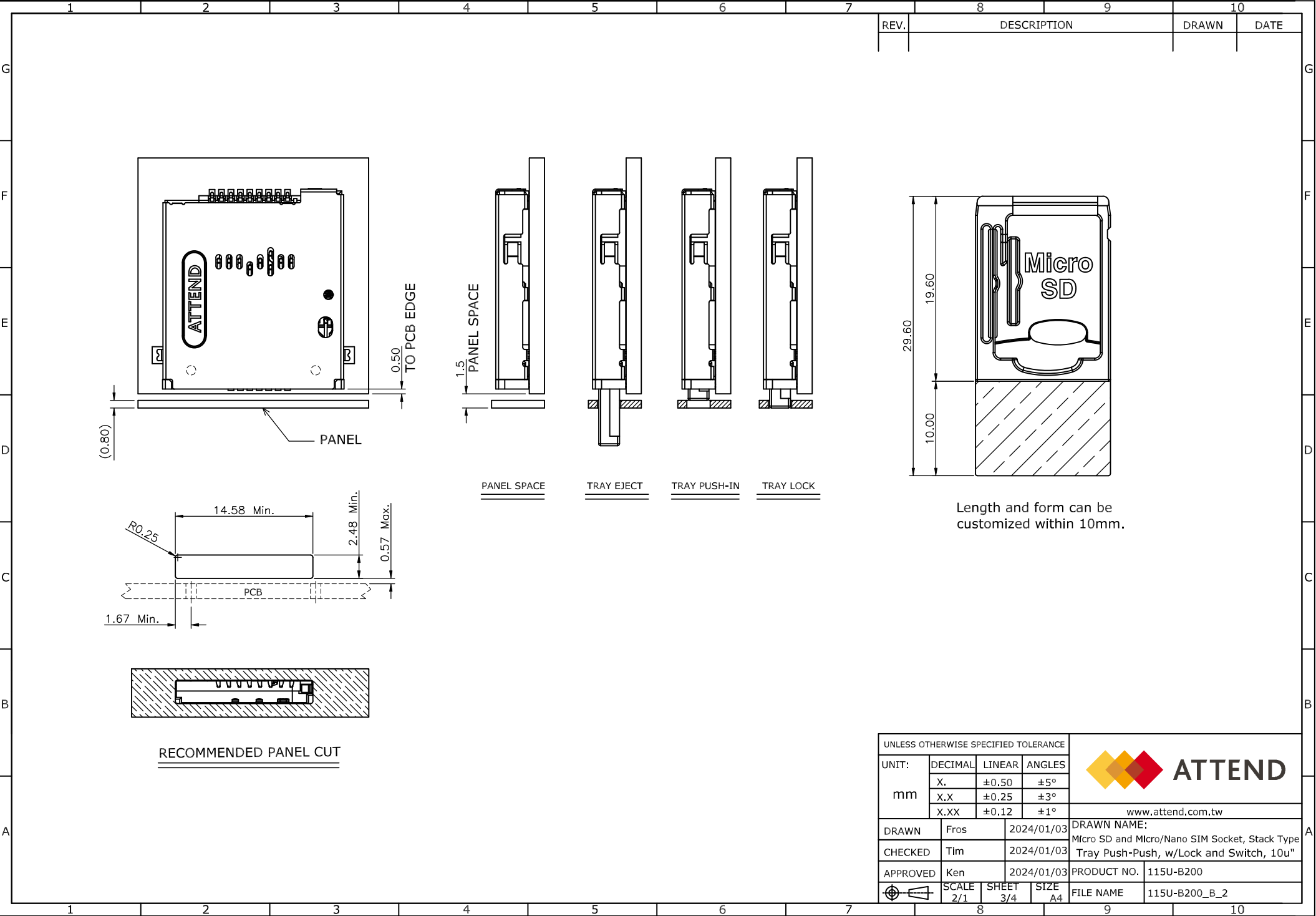
This part (115U-B200) is a connector only, it should be used together with Card-Tray (see page 3, tray spec. table)

6	CRANK	Stainless Steel
5	SPRING	SWP-B, Nickel plating
4	SLIDER	LCP, UL94V-0, Black
3	SHELL	Stainless Steel, Nickel plating
2	LOWER LAYER MOLDING	Contact: Copper alloy, Gold plating over Nickel Insulator: LCP, UL94V-0, Black
	UPPER LAYER MOLDING	Contact: Copper alloy, Gold plating over Nickel Insulator: LCP, UL94V-0, Black
1	MOLDING	Insulator: LCP, UL94V-0, Black

NO.	PART NAME	DESCRIPTION
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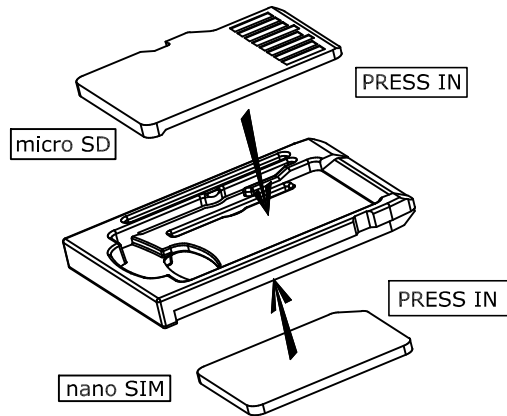
UNLESS OTHERWISE SPECIFIED TOLERANCE				 ATTEND www.attend.com.tw	
UNIT: mm	DECIMAL	LINEAR	ANGLES		
	X.	±0.50	±5°		
	X.X	±0.25	±3°		
	X.XX	±0.12	±1°		
				www.attend.com.tw	
DRAWN	Fros		2024/01/03	DRAWN NAME: Micro SD and Micro/Nano SIM Socket, Stack Type Tray Push-Push, w/Lock and Switch, 10u"	
CHECKED	Tim		2024/01/03		
APPROVED	Ken		2024/01/03	PRODUCT NO.	115U-B200
	SCALE 2/1	SHEET 1/4	SIZE A4	FILE NAME	115U-B200_B_2



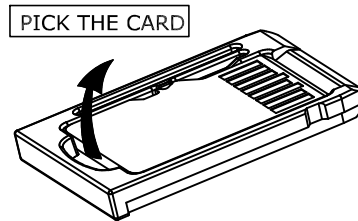


Nano SIM card assembly and disassembly:

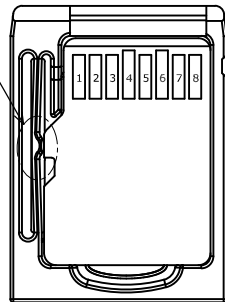
ASSEMBLY



DISASSEMBLY

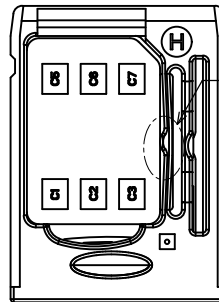


Card Clip hold
Nano SIM card
make it won't
fall.



micro SD

Card Clip hold
Nano SIM card
make it won't
fall.

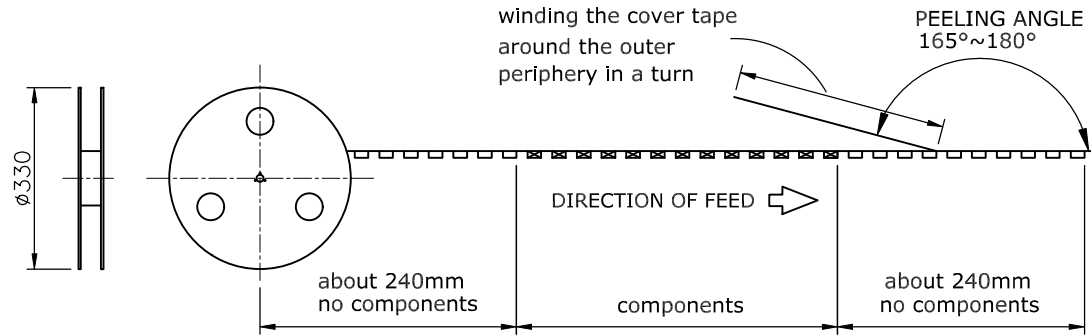


Nano SIM

4	115U-B200 + 115U-T013	Micro SD + Micro SIM, add 2mm length
3	115U-B200 + 115U-T012	Micro SD + Nano SIM, add 2mm length
2	115U-B200 + 115U-T010	Micro SD + Micro SIM, Normal length
1	115U-B200 + 115U-T009	Micro SD + Nano SIM, Normal length
NO.	Matching P/N	DESCRIPTION

UNLESS OTHERWISE SPECIFIED TOLERANCE				ATTEND www.attend.com.tw	
UNIT: mm	DECIMAL	LINEAR	ANGLES		
	X.	±0.50	±5°		
	X.X	±0.25	±3°		
	X.XX	±0.12	±1°		
DRAWN		Fros	2024/01/03	DRAWN NAME: Micro SD and Micro/Nano SIM Socket, Stack Type	
CHECKED		Tim	2024/01/03	Tray Push-Push, w/Lock and Switch, 10u"	
APPROVED		Ken	2024/01/03	PRODUCT NO.	115U-B200
	SCALE 2/1	SHEET 4/4	SIZE A4	FILE NAME	115U-B200_B_2

REV.	DESCRIPTION	DRAWN	DATE
1	INITIAL RELEASE	FROS	2024/01/03



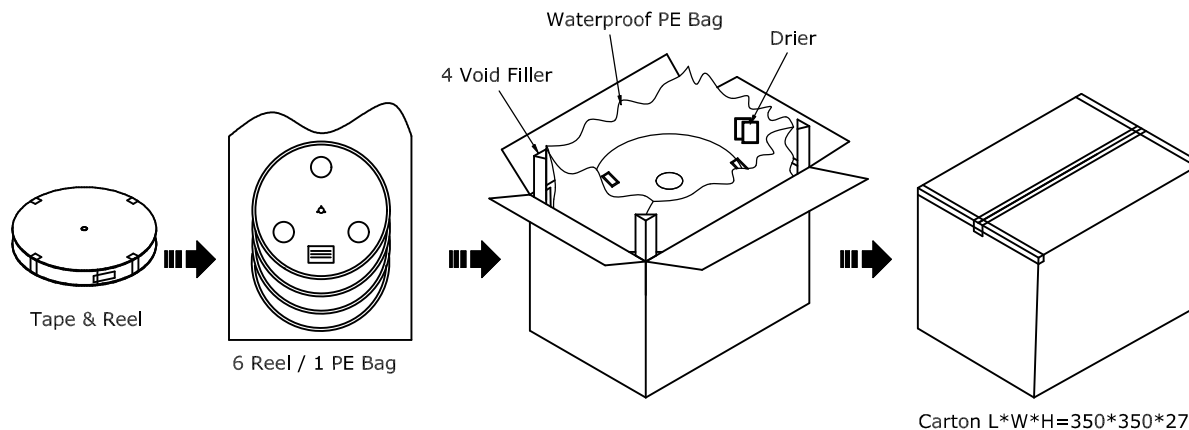
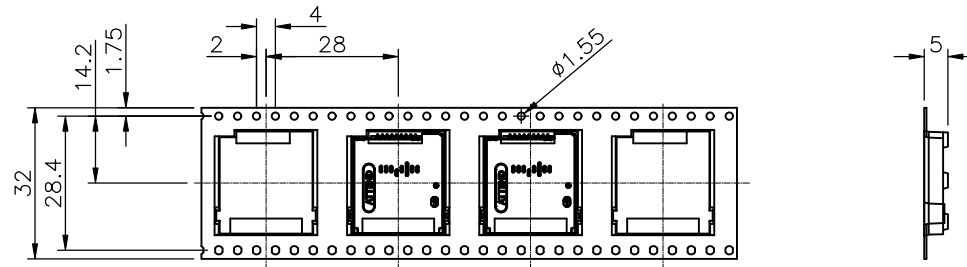
PACKAGING SPECIFICATION:

1. MATERIAL

- 1.1 Embossed Carrier Tape: PS Black
- 1.2 Top Cover Tape: PET
20-80g(Peel Speed 300mm/Minute)
- 1.3 Taping Reel: Paper

2. PACKING

- 2.1 Quantity:
450 Piece/Reel
2700 Piece/Outer Carton



UNLESS OTHERWISE SPECIFIED TOLERANCE				 ATTEND www.attend.com.tw	
UNIT: mm	DECIMAL	LINEAR	ANGLES		
	X.	±0.50	±5°		
	X.X	±0.25	±3°		
	X.XX	±0.12	±1°		
DRAWN	Fros	2024/01/03	DRAWN NAME: Micro SD and Micro/Nano SIM Socket, Stack Type Tray Push-Push, w/Lock and Switch, 10u"		
CHECKED	Tim	2024/01/03			
APPROVED	Ken	2024/01/03	PRODUCT NO.	115U-B200	
	SCALE N/A	SHEET 1/1	SIZE A4	FILE NAME	115U-B200_D_1